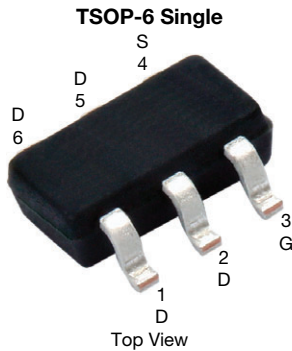


N-Channel 100 V (D-S) MOSFET



Marking code: BW

PRODUCT SUMMARY	
V_{DS} (V)	100
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10$ V	0.160
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 7.5$ V	0.167
Q_g typ. (nC)	2.9
I_D (A) ^d	1.95
Configuration	Single

ORDERING INFORMATION	
Package	TSOP-6
Lead (Pb)-free and halogen-free	Si3122DV-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	100	V
Gate-source voltage		V_{GS}	± 20	
Continuous drain current ($T_J = 150$ °C)	$T_C = 25$ °C	I_D	1.34	A
	$T_C = 70$ °C		0.86	
	$T_A = 25$ °C		1.78 ^{a, b}	
	$T_A = 70$ °C		1.42 ^{a, b}	
Pulsed drain current ($t = 100$ μ s)		I_{DM}	8	
Continuous source-drain diode current	$T_C = 25$ °C	I_S	1.1	
	$T_A = 25$ °C		0.93 ^{a, b}	
Single pulse avalanche current	L = 0.1 mH	I_{AS}	3	mJ
Single pulse avalanche energy		E_{AS}	0.45	
Maximum power dissipation	$T_C = 25$ °C	P_D	1.34	W
	$T_C = 70$ °C		0.86	
	$T_A = 25$ °C		1.11 ^{a, b}	
	$T_A = 70$ °C		0.71 ^{a, b}	
Operating junction and storage temperature range		T_J, T_{stg}	-55 to +150	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^{a, c}	$t \leq 5$ s	R_{thJA}	95	112	°C/W
Maximum junction-to-foot (drain)	Steady state	R_{thJF}	76	93	

Notes

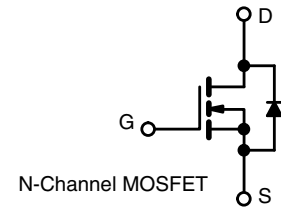
- Surface mounted on 1" x 1" FR4 board
- $t = 5$ s
- Maximum under steady state conditions is 155 °C/W
- $T_C = 25$ °C

FEATURES

- TrenchFET® Gen IV power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- DC/DC converters
- Boost converters
- LED backlighting
- PD switch
- Load switch


RoHS
 COMPLIANT
 HALOGEN
FREE


N-Channel MOSFET



SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	100	-	-	V
V _{DS} temperature coefficient	ΔV _{DS} /T _J	I _D = 250 μA	-	84	-	mV/°C
V _{GS(th)} temperature coefficient	ΔV _{GS(th)} /T _J		-	-6.4	-	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	2	-	4	V
Gate-source leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V	-	-	± 100	nA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V	-	-	1	μA
		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 70 °C	-	-	10	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 2.5 A	-	0.133	0.160	Ω
		V _{GS} = 7.5 V, I _D = 2.0 A	-	0.139	0.167	
Forward transconductance ^a	g _{fs}	V _{DS} = 50 V, I _D = 2.5 A	-	7.0	-	S
Dynamic ^b						
Input capacitance	C _{iSS}	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz	-	210	-	pF
Output capacitance	C _{oSS}		-	28	-	
Reverse transfer capacitance	C _{rSS}		-	6.2	-	
Total gate charge	Q _g	V _{DS} = 50 V, V _{GS} = 10 V, I _D = 2.0 A	-	3.8	6	nC
		V _{DS} = 50 V, V _{GS} = 7.5 V, I _D = 2.0 A	-	2.9	4.5	
Gate-source charge	Q _{gs}		-	1.3	-	
Gate-drain charge	Q _{gd}		-	0.6	-	
Gate resistance	R _g	f = 1 MHz	0.7	1.5	2.5	Ω
Turn-on delay time	t _{d(on)}	V _{DD} = 50 V, R _L = 25 Ω, I _D ≅ 2 A, V _{GEN} = 10 V, R _g = 1 Ω	-	7	14	ns
Rise time	t _r		-	4	8	
Turn-off delay time	t _{d(off)}		-	10	20	
Fall time	t _f		-	3	6	
Turn-on delay time	t _{d(on)}	V _{DD} = 50 V, R _L = 25 Ω, I _D ≅ 2 A, V _{GEN} = 7.5 V, R _g = 1 Ω	-	8	16	
Rise time	t _r		-	4	8	
Turn-off delay time	t _{d(off)}		-	10	20	
Fall time	t _f		-	3	6	
Drain-Source Body Diode Characteristics						
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	1.1	A
Pulse diode forward current	I _{SM}		-	-	8	
Body diode voltage	V _{SD}	I _S = 1.3 A, V _{GS} = 0 V	-	0.85	1.2	V
Body diode reverse recovery time	t _{rr}	I _F = 1.3 A, di/dt = 100 A/μs, T _J = 25 °C	-	22	44	ns
Body diode reverse recovery charge	Q _{rr}		-	23	46	nC
Reverse recovery fall time	t _a		-	19	-	ns
Reverse recovery rise time	t _b		-	3	-	

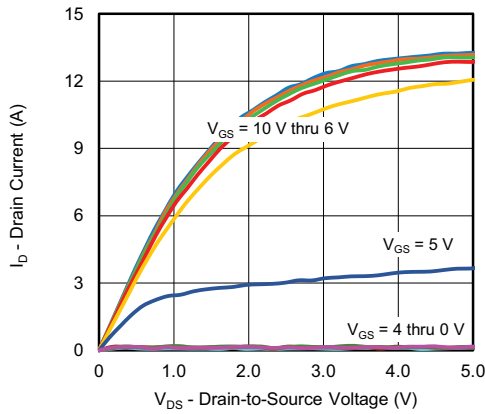
Notes

- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %
- b. Guaranteed by design, not subject to production testing

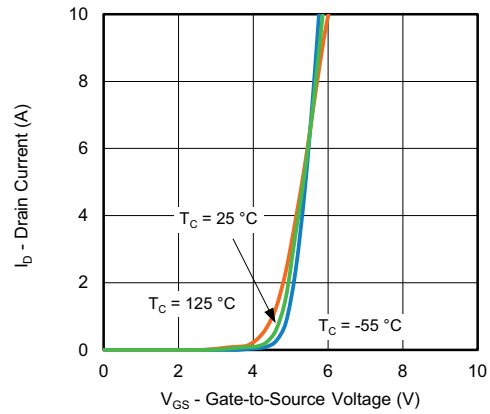
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



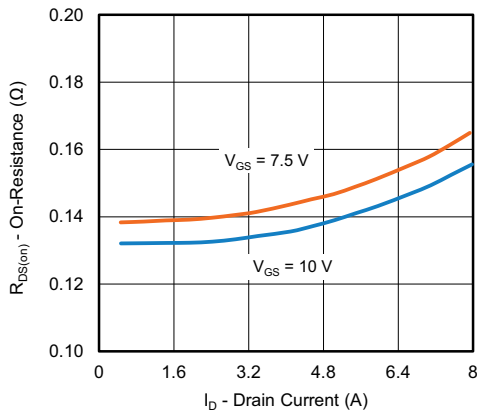
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



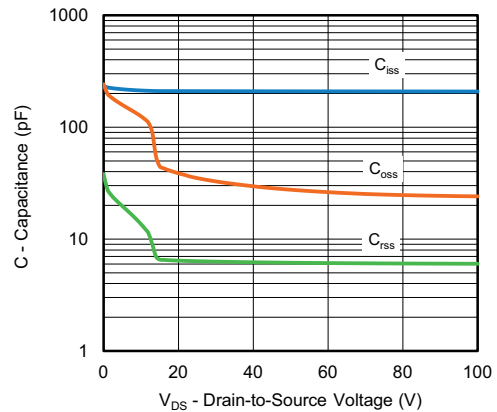
Output Characteristics



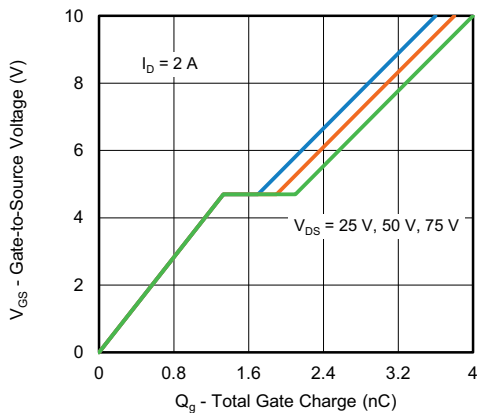
Transfer Characteristics



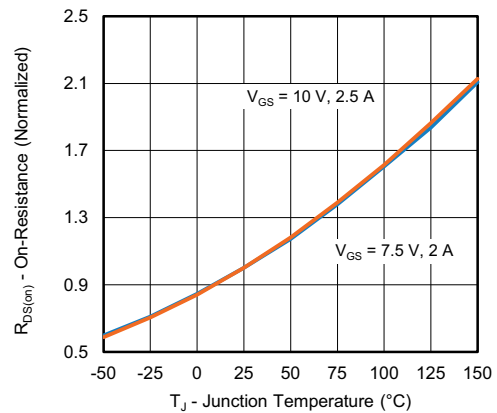
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



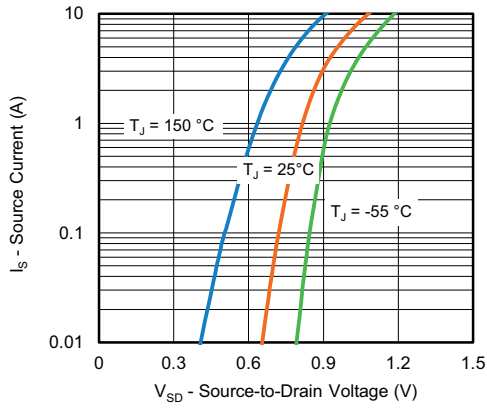
Gate Charge



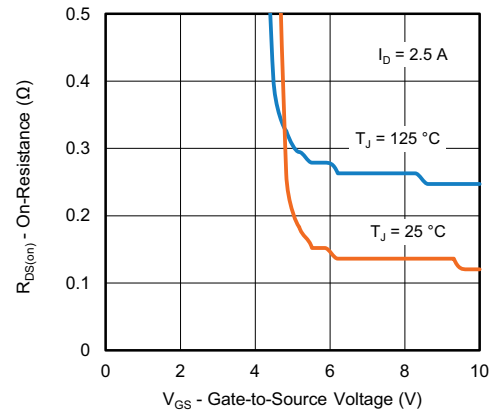
On-Resistance vs. Junction Temperature



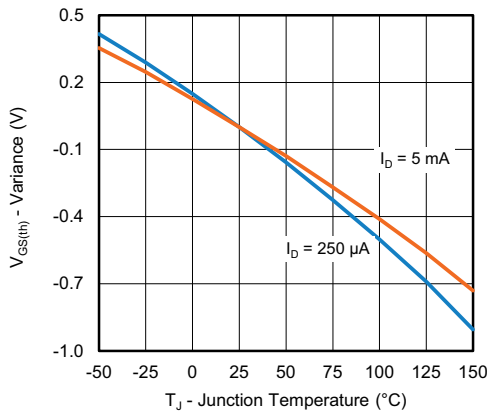
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



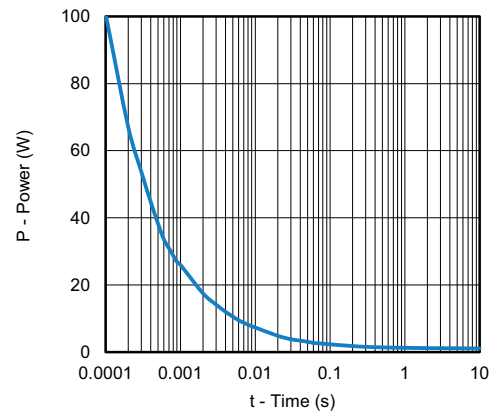
Source-Drain Diode Forward Voltage



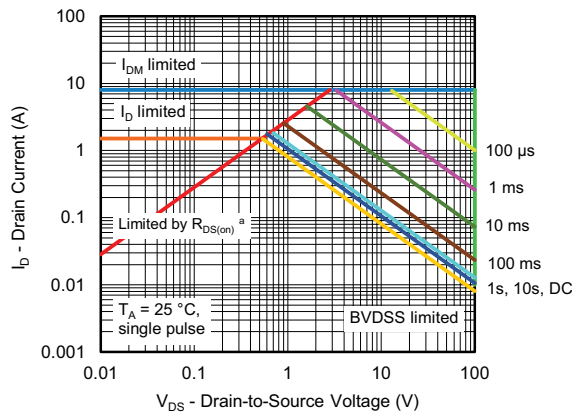
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



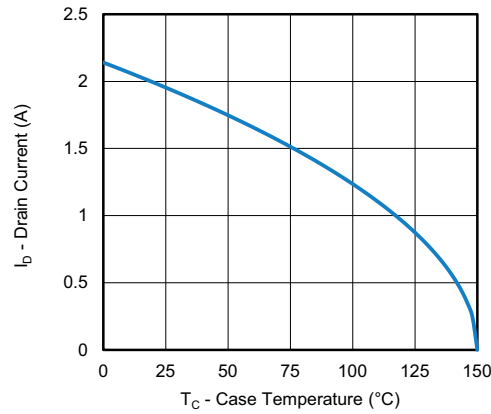
Single Pulse Power, Junction-to-Ambient



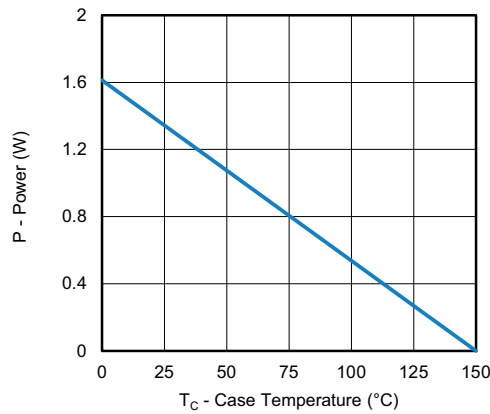
Safe Operating Area, Junction-to-Ambient



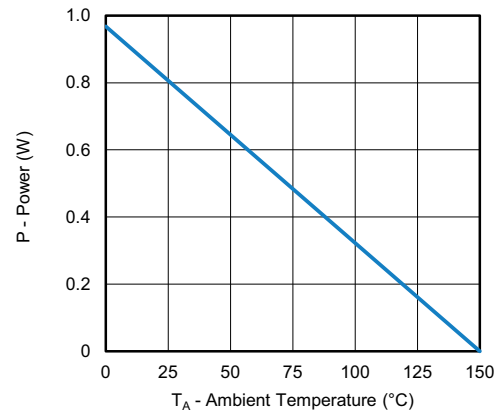
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating ^a



Power, Junction-to-Case



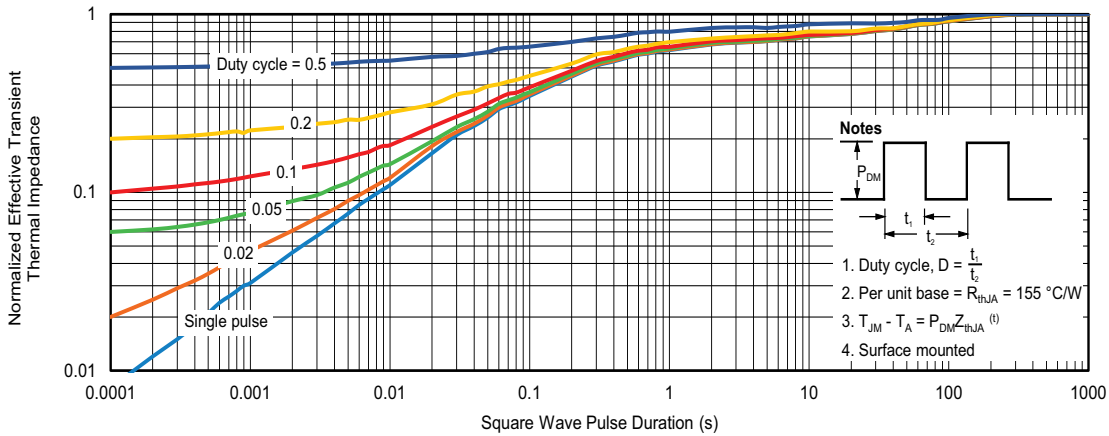
Power, Junction-to-Ambient

Note

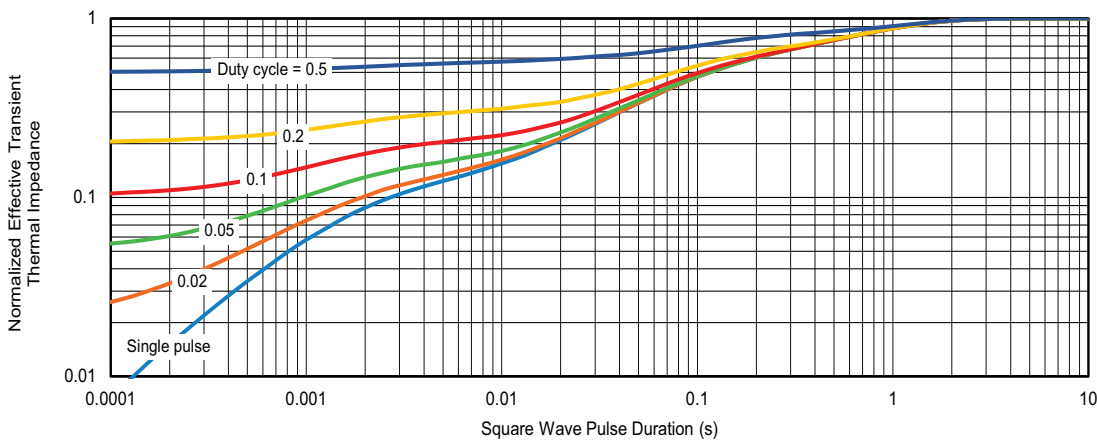
- a. The power dissipation P_D is based on $T_J \text{ max.} = 150 \text{ }^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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